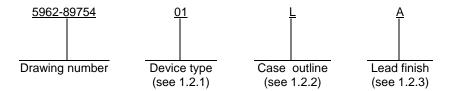
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REV SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STA	NDARD DCIRCUIT AWING		REV SHE PREI La CHEC Ti	CKED of the H. N	D BY Gauder BY Noh	C 1	С	С	4	5	6 CC http:	7 DLA I DLUM	AND BUS	9 AND, OHIO	10 MAR O 432 mariti	11 RITIMI 218-39 me.d	12 E 990 la.mil	13	
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REV SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STAI MICRO DRA THIS DRAWIT FOR U DEPA	NDARD DCIRCUIT AWING NG IS AVAILL ISE BY ALL RTMENTS	ABLE	REV SHE PREI La CHEO Ti	CKED im H. N	D BY Gauder BY Noh	C 1	C 2	С	MIC AD	5 CROC	6 CC http:	DLA I	AND BUS, w.land	9 AND, OHIO	D MAR D 432 mariti	11 RITIMI 218-39 me.d	12 E 990 la.mil	13	
REV SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STAI MICRO DRA THIS DRAWIT FOR U DEPA	NDARD DCIRCUIT AWING NG IS AVAILL ISE BY ALL RTMENTS NCIES OF TH	ABLE	REV SHE PREI La CHEO Ti	CKED im H. N	D BY Gauden BY Noh D BY pool	C 1	C 2	С	MIC AD'	5 CROC VANC ANSC	6 CC http:	7 DLA I DLUM //www	AND BUS, w.land	9 AND	D MAR D 432 mariti	11 RITIMI 218-39 me.d	12 E 990 la.mil	13	
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REV SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STAI MICRO DRA THIS DRAWII FOR U DEPA AND AGEI DEPARTMEN	NDARD DCIRCUIT AWING NG IS AVAILL ISE BY ALL RTMENTS NCIES OF TH	ABLE	REV SHE PREI La CHEO Ti APPI D.	CKED im H. N	D BY Gaudel BY Noh D BY DOI APPRO 89-1 LEVEL	C 1	C 2	С	MIC AD' TR/ MO	SROC VANC ANSC	6 CC http:	DLA I	BLAND IBUS, w.land DIGIT DTTK REGICON	9 AND	D MAR D 432 mariti BIPO TL, RS,	11 RITIMI 218-39 me.d	12 E 990 la.mil	13	

1. SCOPE

- 1.1 <u>Scope</u>. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.
 - 1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 <u>Device type</u>. The device type identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54F646	Transceivers/registers
02	54F648	Transceivers/registers, inverted

1.2.2 <u>Case outlines</u>. The case outlines are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
L	GDIP3-T24 or CDIP4-T24	24	dual-in-line
K	GDFP2-F24 or CDFP3-F24	24	flat
3	CQCC1-N28	28	square chip carrier

- 1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.
- 1.3 Absolute maximum ratings.

Supply voltage range Input voltage range Input current range Voltage applied to any output in the disabled state Voltage applied to any output in the high state Current into any output in the low state Maximum power dissipation (P_D) Storage temperature range Ambient temperature under bias Lead temperature (soldering, 10 seconds) Junction temperature (T_J) Thermal resistance, junction-to-case (θ_{JC})	-0.5 V dc to +7.0 V dc -0.5 V dc to +7.0 V dc -30 mA to +5.0 mA -0.5 V dc to +5.5 V dc -0.5 V dc to V _{CC} 96 mA 825 mW 1/ -65°C to +150°C -55°C to +125°C +300°C +175°C See MIL-STD-1835
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1.4 Recommended operating conditions.

Supply voltage range (V _{CC})	+4.5 V dc minimum to +5.5 V dc maximum
Minimum high level input voltage (V _{IH})	2.0 V dc
Maximum low level input voltage (V _{IL})	0.8 V dc
Maximum input clamp current (I _{IC})	-18 mA
Maximum high level output current (I _{OH})	
Maximum low level output current (I _{OL})	+48 mA
Case operating temperature range (T _C)	-55°C to +125°C

 $[\]underline{1}$ / Maximum power dissipation is defined as V_{CC} X I_{CC} , and must withstand the added P_D due to short circuit output test e.g., I_O .

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1.4 Recommended operating conditions - Continued.

Setup time An, Bn, \overline{A} n, \overline{B} n to CPAB, CPBA (t _s)	5.0 ns
Hold time, An, Bn, \overline{A} n, \overline{B} n to CPAB, CPBA (t _h):	
$T_C = +25^{\circ}C$	1.5 ns
$T_C = -55^{\circ}C$, +125°C	2.5 ns
Pulse width CPAB, CPBA	5.0 ns
Maximum clock frequency (f _{MAX}):	
$T_C = +25^{\circ}C$	90 MHz
$T_C = -55^{\circ}C$, +125°C	75 MHz

2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at https://assist.daps.dla.mil/quicksearch/ or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

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3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.
 - 3.2.1 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2 herein.
 - 3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.3 Truth tables. The truth tables shall be as specified on figure 2.
 - 3.2.4 Logic diagrams. The logic diagrams shall be as specified on figure 3.
 - 3.2.5 Test circuit and switching waveforms. Test circuit and switching waveforms shall be as specified on figure 4.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- 3.5 <u>Marking</u>. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.
- 3.5.1 <u>Certification/compliance mark.</u> A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.
- 3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DLA Land and Maritime -VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change</u>. Notification of change to DLA Land and Maritime -VA shall be required for any change that affects this drawing.
- 3.9 <u>Verification and review</u>. DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

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TABLE I. <u>Electrical performance characteristics</u>.

Test	Symbol	$ \begin{array}{c} \text{Conditions} \\ \text{-55°C} \leq \text{T}_{\text{C}} \leq +125^{\circ}\text{C} \\ \text{unless otherwise specified} \\ \end{array} $		Group A subgroups	Device type	Limits		Unit
						Min	Max	
High level output voltage	V _{OH}	$V_{CC} = 4.5 \text{ V},$ $V_{IL} = 0.8 \text{ V}$	I _{OH} = -12 mA	1, 2, 3	All	2.0		V
Low level output voltage	V _{OL}	$V_{IH} = 2.0 V,$	I _{OL} = 48 mA	1, 2, 3	All		0.55	V
Input clamp voltage	V _{IC}		I _C = -18 mA	1, 2, 3	All		-1.2	V
High level input current	I _{IH1}	V _{CC} = 5.5 V	V _{IN} = 2.7 V (non I/O pins)	1, 2, 3	All		20	μА
	I _{IH2}	<u>1</u> /	$V_{IN} = 7.0 \text{ V}$				100	
	I _{IH3}		$V_{IN} = 5.5 \text{ V}$ (I/O pins)				1.0	mA
Low level input current	I _{IL}		$V_{IN} = 0.5 V$ (non I/O pins)	1, 2, 3	All		-0.6	mA
Short circuit output current	I _{OS}	V _{CC} = 5.5 V 2/	V _{OUT} = 0.0 V	1, 2, 3	All	-100	-225	mA
Off-state output current	I _{OZH}	$V_{CC} = 5.5 \text{ V},$	V _{IN} = 2.7 V	1, 2, 3	01		70	μА
	I _{OZL}	V _{IH} = 2.1 V	$V_{IN} = 0.5 \text{ V}$		01		-650	
	I _{OZH}	$V_{CC} = 5.5 \text{ V},$	$V_{IN} = 2.7 \text{ V}$		02		70	
	l _{OZL}	$V_{IH} = 2.0 V$	$V_{IN} = 0.5 V$		02		-650	
Supply current	I _{CCH}	$V_{CC} = 5.5 \text{ V}$		1, 2, 3	All		135	mA
	I _{CCL}						150	_
	I _{CCZ}						150	
Functional tests		See 4.3.1c		7, 8	All			

See footnotes at end of table.

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TABLE I. <u>Electrical performance characteristics</u> - Continued.

Test	Symbol	-55°C	Conditions $C \leq T_C \leq +125^{\circ}C$ therwise specified	Group A subgroups	Device type	Lir	mits	Unit
			•	0009,	71-	Min	Max	1
Propagation delay time,	t _{PLH1}	C _L = 50 pF	V _{CC} = 5.0 V	9	All	1	7	ns
An, Bn to Bn, An or \overline{A} n,		$R_1 = 500\Omega$	V _{CC} = 4.5 V	10, 11	01	1	8	1
\overline{B} n to \overline{B} n, \overline{A} n		$R_2 = 500\Omega$	to 5.5 V		02	1	9	1
D.	t _{PHL1}	see figure 4	V _{CC} = 5.0 V	9	All	1	6.5	1
			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	<u></u> '	1	8	1
Propagation delay time,	t _{PLH2}	1	V _{CC} = 5.0 V	9	All	2	7	ns
CPBA, CPAB to An, Bn,	<u> </u>		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	l'	2	8.5	1
An, Bn	t _{PHL2}	1	V _{CC} = 5.0 V	9	All	2	8	7
, 	<u> </u>		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	<u></u> '	2	9.5	1
Propagation delay time,	t _{PLH3}	1	$V_{CC} = 5.0 \text{ V}$	9	All	2	8.5	ns
SBA, SAB to An, Bn,			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11		2	11]
An, Bn	t _{PHL3}		$V_{CC} = 5.0 \text{ V}$	9	All	2	8]
			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	l'	2	10	1
Output enable time,	t _{PZH1}		$V_{CC} = 5.0 \text{ V}$	9	All	2	8.5	ns
\overline{OE} to An, Bn, \overline{A} n, \overline{B} n			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	!	2	10]
	t _{PZL1}	1	V _{CC} = 5.0 V	9	All	2	8.5	1
			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	'	2	10	1
Output enable time,	t _{PZH2}	1	V _{CC} = 5.0 V	9	All	2	8.5	ns
DIR to An, Bn, \overline{A} n, \overline{B} n			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	·	2	10	7
- · · · · · · · · · · · · · · · · · · ·	t _{PZL2}	1	V _{CC} = 5.0 V	9	All	2	10	1
			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	ļ <u> </u>	2	12	1
Output disable time,	t _{PHZ1}		$V_{CC} = 5.0 \text{ V}$	9	All	1	7.5	ns
\overline{OE} to An, Bn, \overline{A} n, \overline{B} n			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	!	1	9]
 , .	t _{PLZ1}	=	V _{CC} = 5.0 V	9	All	1	7.5	7
			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	<u></u> '	1	9	1
Output disable time,	t _{PHZ2}	1	V _{CC} = 5.0 V	9	All	1	7.5	ns
DIR to An, Bn, \overline{A} n, \overline{B} n			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	·	1	9	7
•	t _{PLZ2}		V _{CC} = 5.0 V	9	All	1	10	1
			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	10, 11	1 '	1	12	7

 $[\]underline{1}/$ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

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Not more than one output will be shorted at one time and the duration of the short circuit condition shall not exceed one second.

Device type	01	1	02	2
Case outlines	K and L	3	K and L	3
Terminal number	Terminal	symbol	Terminal symbol	
1	CPAB	NC	CPAB	NC
2	SAB	CPAB	SAB	CPAB
3	DIR	SAB	DIR	SAB
4	A ₁	DIR	Ā ₁	DIR
5	A ₂	A ₁	$\frac{\overline{A}}{B}_2$	A 1
6	A ₃	A ₂	Ā 3	\overline{A}_2
7	A_4	A ₃	A 4 A 5 A 6	- A 3
8	A ₅	NC	A 5	NC
9	A ₆	A_4	\overline{A}_{6}	A 4
10	A ₇	A ₅	Ā ₇	<u>A</u> 5
11	A ₈	A ₆	\overline{A}_{8}	\overline{A}_{6}
12	GND	A ₇	GND	$\frac{\overline{A}}{\overline{A}}_{7}$
13	B ₈	A ₈	∃ ₈	A 8
14	B ₇	GND	B ₇	GND
15	B ₆	NC	\overline{B}_{6}	NC
16	B ₅	B ₈	B ₅	_ B ₈
17	B_4	B ₇	_ B ₄	_ B ₇
18	B ₃	B ₆	Б _з	B ₆
19	B_2	B ₅	\overline{B}_{2}	B ₅
20	B ₁	B_4	_ B₁	_ B ₄
21	ŌĒ	B ₃	ŌĒ	Б _з
22	SBA	NC	SBA	NC
23	CPBA	B_2	CPBA	\overline{B}_2
24	V _{CC}	B ₁	Vcc	 B ₁
25		ŌĒ		ŌĒ
26		SBA		SBA
27		СРВА		СРВА
28		V _{CC}		V _{CC}

NC = No connection

FIGURE 1. <u>Terminal connections</u>.

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Device type 01

		Inp	uts			Inputs/Out	tputs <u>1</u> /	Operation mode
DIR	ŌĒ	CPAB	СРВА	SAB	SBA	A ₀ through A ₇	B ₀ through B ₇	- operation mode
Х	Н	H/L	H/L	Х	Х	Input	Input	Isolation
Х	Н	1	1	Χ	Х	Input	Input	Store A and B data
L	L	X	Χ	Х	L	Output	Input	Real time B data to A bus
L	L	X	Х	Х	Н	Output	Input	Stored B data to A bus
Н	L	X	Х	L	Х	Input	Output	Real time A data to B bus
Н	L	H/L	Х	Н	Х	Input	Output	Stored A data to B bus

Device type 02

		Inp	uts			Inputs/Outputs 1/		Operation mode
DIR	ŌE	CPAB	СРВА	SAB	SBA	\overline{A}_0 through \overline{A}_7	\overline{B}_0 through \overline{B}_7	operation mode
Х	Н	H/L	H/L	Х	Х	Input	Input	Isolation
X	Н	↑	1	Χ	X	Input	Input	Store A and B data
L	L	X	X	Х	L	Output	Input	Real time B data to A bus
L	L	X	X	Х	Н	Output	Input	Stored B data to A bus
Н	L	Х	Χ	L	X	Input	Output	Real time A data to B bus
Н	L	H/L	X	Н	X	Input	Output	Stored A data to B bus

H = High voltage levelL = Low voltage level

H/L = High or low voltage level

X = Irrelevant

↑ = Low to high clock transition

NOTES:

1. The data output functions may be enabled or disabled by various signals at the $\overline{\text{OE}}$ or DIR inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low to high transition of the clock inputs.

FIGURE 2. Truth tables.

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DEVICE TYPE 01

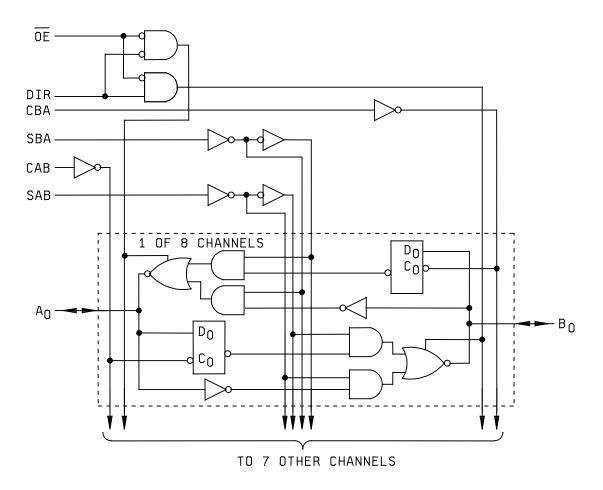


FIGURE 3. Logic diagrams.

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DEVICE TYPE 02

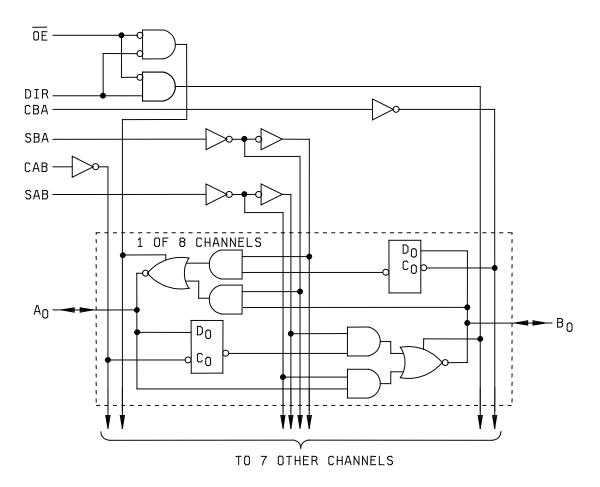
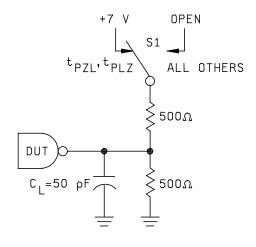
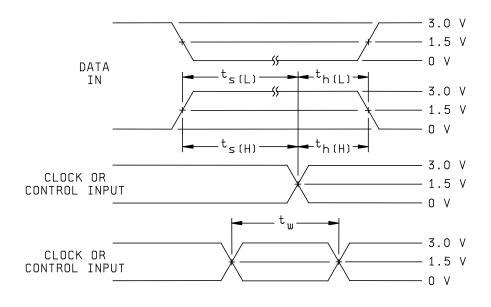


FIGURE 3. Logic diagrams - Continued.

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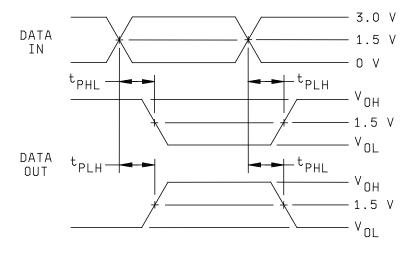




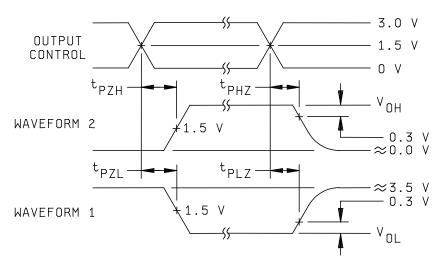
SETUP TIME, HOLD TIME AND PULSE WIDTHS

FIGURE 4. Test circuits and switching waveforms.

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PROPAGATION DELAY TIME



THREE-STATE OUTPUT HIGH AND LOW ENABLE AND DISABLE TIMES

NOTES:

- 1. C_L includes probe and jig capacitance.
- 2. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 - Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- 3. All input pulses have the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_f = 2.5$ ns.
- 4. When measuring propagation delay times of three-state outputs, switch S1 is open.
- 5. When measuring pulse widths $t_r = t_f \le 1$ ns.
- 6. The outputs are measured one at a time with one input transition per measurement.

FIGURE 4. Test circuit and switching waveforms.

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4. VERIFICATION

- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

^{*} PDA applies to subgroup 1.

- 4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - c. Subgroups 7 and 8 shall include verification of the truth table.

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4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.
- 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.
- 6.4 <u>Record of users</u>. Military and industrial users shall inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DLA Land and Maritime -VA, telephone (614) 692-0547.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DLA Land and Maritime -VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0540.
- 6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime -VA.

STANDARD		
MICROCIRCUIT DRAWING		
DLA LAND AND MADITIME		

DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 12-09-05

Approved sources of supply for SMD 5962-89754 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime -VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at http://www.landandmaritime.dla.mil/Programs/Smcr/.

Vendor	Vendor
CAGE	similar
number	PIN <u>2</u> /
27014	54F646/QKA
3V146	54F648/BKA
3V146	54F646/QKA
0C7V7	54F646FMQB
<u>3</u> /	54F648/BKA
27014	54F646/QLA
27014	54F648/BLA
3V146	54F648/BLA
0C7V7	54F646SDMQB
3V146	54F646/QLA
27014	54F646/Q3A
3V146	54F646/Q3A
0C7V7	54F646LMQB
3V146	54F648/B3A
27014	54F648/B3A
	CAGE number 27014 3V146 3V146 0C7V7 3/ 27014 27014 3V146 0C7V7 3V146 27014 3V146 0C7V7 3V146 0C7V7 3V146

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- <u>2</u>/ <u>Caution</u>. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 3/ Not available from an approved source of supply.

Vendor CAGE number	Vendor name and address
27014	National Semiconductor 2900 Semiconductor Drive P.O. Box 58090 Santa Clara, CA 95052-8090
3V146	Rochester Electronics Inc. 16 Malcolm Hoyt Drive Newburyport, MA 01950
0C7V7	E2V Aerospace and Defense, Inc. dba QP semiconductor, Inc. 765 Sycamore Drive Milpitas, CA 95035

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.